

Solid State Broadband High Power Amplifier

1164 – BBM3Q6AHM

800 - 3000 MHz / 50 Watts

The BBM3Q6AHM (SKU 1164) is suitable for broadband mobile jamming and band-specific high power linear applications in the P/L/S frequency bands. This compact module utilizes high power advanced GaN devices that provide excellent power density, high efficiency, wide dynamic range and low distortion. Exceptional performance, long term reliability and high efficiency are achieved by employing advanced broadband RF matching networks and combining techniques, EMI/RFI filters, machined housings and qualified components. Empower RF's ISO9001 Quality Assurance Program assures consistent performance and the highest reliability.



- Solid-state Class AB linear design
- Extremely wide instantaneous bandwidth
- Small form factor and lightweight
- Built-in control, monitoring and protection circuits
- Suitable for CW, AM, and FM (Consult Factory for other modulation types)
- 50 ohm input/output impedance
- Highly rugged and reliable

ELECTRICAL SPECIFICATIONS @ +28.0V_{DC}, 25 °C, 50 Ω System

Parameter	Symbol	Min	Тур	Max	Unit
Operating Frequency	BW	800		3000	MHz
Output Power CW	P _{SAT}	50			Watt
Output Power @ 1dB Gain Compression	P _{1dB}	20			Watt
Power Gain @ P _{1dB}	G _{1dB}	46	50	53	dB
Input Power for Rated P _{SAT}	P _{IN}		0		dBm
Small Signal Gain Flatness	ΔG			±2.0	dB
Input Return Loss	S ₁₁			-10	dB
Noise Figure @ Max Gain	NF			10.5	dB
Third Order Intercept Point 2-Tone @ 41dBm/Tone, 1MHz Spacing	IP3	+50			dBm
Harmonics @ P _{OUT} = 20W	2 nd / 3 rd			-17/-20	dBc
Spurious Signals	Spur			-60	dBc
Operating Voltage	V_{DC}	27.4	28	28.6	Volt
Current Consumption @ Shutdown	I _{SD}		100	350	mA
Current Consumption @ P _{OUT} = 50W	I _{DD}		5.3	6.3	Amp
Quiescent Current	I_{DQ}		2.0	3.0	Amp
Switching Speed (10% to 90%)	T _{ON/OFF}		2.0	5.0	μs

MECHANICAL SPECIFICATIONS

Parameter	Value	Units	Limits
Dimensions	6.4 x 3.4 x 1.1	Inch	Max
Weight	1.2	lb.	Max
RF Connectors Input/Output	Type-SMA, Female		
DC Interface Connector	D-Sub 9-Pin, Male		
Cooling	External Heatsink (Not Supplied)		

ENVIRONMENTAL CHARACTERISTICS (Design to Meet)

Parameter	Symbol	Min	Тур	Max	Unit
Operating Case Temperature	T _C	-40		+85	°C
Storage Temperature	T _{STG}	-40		+85	°C
Relative Humidity (non-condensing)	RH			95	%
Altitude (MIL-STD-810F Method 500.4)	ALT			30,000	Feet
Vibration/Shock MIL-STD-810F Method 514.5/516.5 Proc 1	VI/SH		Airborne		



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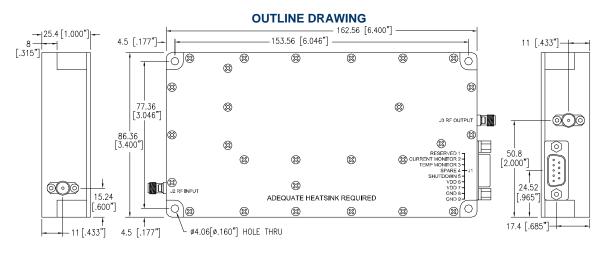
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LIMITS

Input RF drive level without damage	+10 dBm	Max
Load VSWR @ P _{OUT} = 50W		-
Thermal Overload	85°C Graceful Degradation	-

DC INTERFACE CONNECTOR - D-Sub 9-Pin, Male

Pin #	Description	Specifications
1	Reserved	No Connection
2	Current Monitor	Analog voltage relative to I _{DD} @ 50mV/100mA
3	Temp Monitor	Analog voltage relative to module temperature @ 10mV/°C
4	Spare	No Connection
5	Shutdown	Amplifier Disable: TTL Logic High (5V) (Internally Pulled-Low)
6, 7	VDD	+28.0V _{DC} ±0.6V
8, 9	GND	Ground



TYPICAL PERFORMANCE PLOTS

